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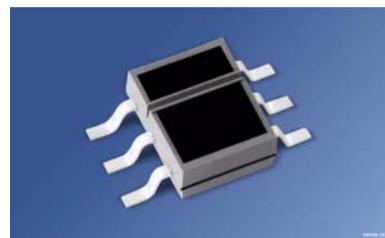
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# Reflexlichtschranke mit Schmitt-Trigger Reflective Interrupter with Schmitt-Trigger

**SFH 9240**  
**SFH 9241**



## Wesentliche Merkmale

- IR-GaAs-Lumineszenzdiode in Kombination mit einem Schmitt-Trigger IC
- SFH 9240: Output active low
- SFH 9241: Output active high
- Tageslichtsperrfilter
- Einschaltstrom: typ. 3 mA
- Sender und Empfänger galvanisch getrennt

## Anwendungen

- Optischer Schalter
- Pulsformer
- Zähler

## Features

- IR-GaAs-emitter in combination with a Schmitt-Trigger IC
- SFH 9240: Output active low
- SFH 9241: Output active high
- Daylight cut-off filter
- Threshold current: typ. 3 mA
- Emitter and detector electrically isolated

## Applications

- Optical threshold switch
- Pulseformer
- Counter

Typ Type	Bestellnummer Ordering Code	Gehäuse Package
SFH 9240	Q62702-P5118	P-DSO-6 Gehäuse mit Tageslichtsperrfilter, Anschlüsse im 1.27 mm - Raster, Ausgang: active low P-DSO-6 package with daylight-cutoff-filter, lead spacing 1.27 mm (1/20"), Output active low
SFH 9241	Q62702-P5119	P-DSO-6 Gehäuse mit Tageslichtsperrfilter, Anschlüsse im 1.27 mm - Raster, Ausgang: active high P-DSO-6 package with daylight cut-off filter, lead spacing 1.27 mm (1/20"), Output active high

**Grenzwerte** ( $T_A = 25\text{ °C}$ )**Maximum Ratings**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
<b>Sender</b> (GaAs-Diode) <b>Emitter</b> (GaAs diode)			
Sperrspannung Reverse voltage	$V_R$	5	V
Vorwärtsgleichstrom Forward current	$I_F$	50	mA
Stoßstrom ( $t_p \leq 10\ \mu\text{s}$ ) Surge current ( $t_p \leq 10\ \mu\text{s}$ )	$I_{FSM}$	1.5	A
Verlustleistung Power dissipation	$P_{tot}$	80	mW

**Empfänger** (Schmitt-Trigger IC)**Detector** (Schmitt-Trigger IC)

Versorgungsspannung Supply voltage	$V_{CC}$	- 0.5 ... + 20	V
Ausgangsspannung Output voltage	$V_O$	- 0.5 ... + 20	V
Ausgangsstrom Output current ( $T_A = 25\text{ °C}$ )	$I_O$	20	mA
Verlustleistung Power dissipation	$P_{tot}$	100	mW

**Reflexlichtschranke****Light Reflection Switch**

Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{op}, T_{stg}$	- 40 ... + 100	°C
Verlustleistung Power dissipation	$P_{tot}$	150	mW

Kennwerte ( $T_A = 25\text{ °C}$ )

## Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
<b>Sender</b> (GaAs-Diode) <b>Emitter</b> (GaAs diode)			
Durchlassspannung Forward voltage $I_F = 50\text{ mA}$	$V_F$	1.25 ( $\leq 1.65$ )	V
Sperrstrom Reverse current $V_R = 5\text{ V}$	$I_R$	0.01 ( $\leq 1$ )	$\mu\text{A}$
Kapazität Capacitance $V_R = 0\text{ V}, f = 1\text{ MHz}$	$C_O$	25	pF
Wärmewiderstand (Montage auf PC-Board mit > 5 mm <sup>2</sup> Padgröße) Thermal resistance (mounting on pcb with > 5 mm <sup>2</sup> pad size)	$R_{thJA}$	400	K/W

**Empfänger** (Schmitt-Trigger IC) (wenn nicht anders angegeben,  $V_{CC} = 5\text{ V}$ )**Detector** (Schmitt-Trigger IC) (unless otherwise specified,  $V_{CC} = 5\text{ V}$ )

Ausgangsspannung „high“ Output voltage “high” $I_O = 0$	$V_{OH}$	$V_{CC} (> 4.0)$	V
Ausgangsspannung „low“ Output voltage “low” $I_O = 16\text{ mA}$	$V_{OL}$	0.15 ( $< 0.4$ )	V
Stromaufnahme Supply current $V_{CC} = 5\text{ V}$ $V_{CC} = 18\text{ V}$	$I_{CC}$	3.3 ( $< 5$ ) 5.0	mA
Anstiegszeit 10% bis 90% Rise time 10% to 90% $R_L = 280\ \Omega, I_F = 20\text{ mA}$	$t_r$	SFH9240 20	SFH9241 30 ns
Abfallzeit 90% bis 10% Fall time 90% to 10% $R_L = 280\ \Omega, I_F = 20\text{ mA}$	$t_f$	SFH9240 10	SFH9241 20 ns

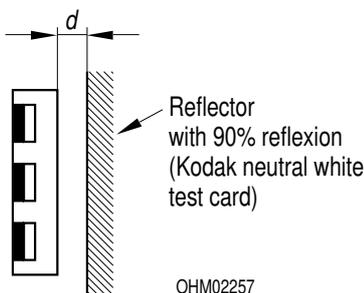
Kennwerte ( $T_A = 25\text{ °C}$ )

Characteristics (cont'd)

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Ausgangsverzögerungszeit Propagation delay time "ON" $R_L = 280\ \Omega$ , $I_F = 20\text{ mA}$	$t_{ON}$	1	$\mu\text{s}$
Ausgangsverzögerungszeit Propagation delay time "OFF" $R_L = 280\ \Omega$ , $I_F = 20\text{ mA}$	$t_{OFF}$	2	$\mu\text{s}$

**Reflexlichtschranke****Light Reflection Switch**

Schaltsschwelle Threshold current, Kodak neutral white test card with 90% reflection $V_{CC} = 5\text{ V}$ , $d = 1\text{ mm}$	$I_{F, ON}$	3 (< 10)	mA
Hysterese Hysteresis	$I_{F, OFF} / I_{F, ON}$	0.6 (0.5 ... 0.9)	–

**Zulässiger Arbeitsbereich****Operating Conditions**

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Versorgungsspannung Supply voltage	$V_{CC}$	4 ... 18	V
Ausgangsstrom Output current	$I_O$	< 16	mA

Zur Stabilisierung der Versorgung wird ein Stützkondensator (angeschlossen zwischen  $V_{CC}$  und GND) von typ.  $0.1\ \mu\text{F}$  empfohlen.

A bypass capacitor,  $0.1\ \mu\text{F}$  typical, connected between  $V_{CC}$  and GND is recommended in order to stabilize power supply line.

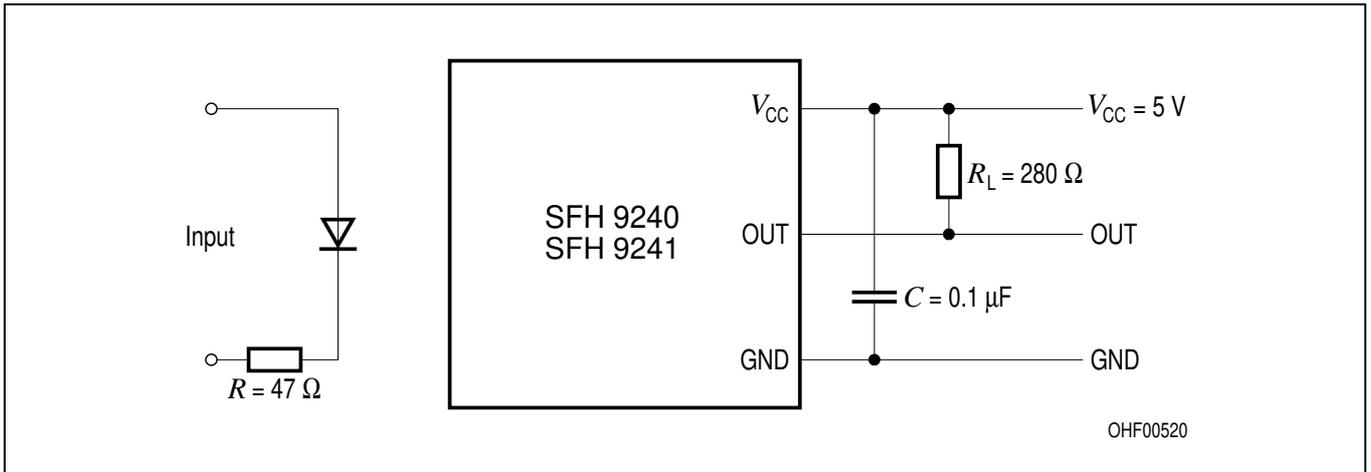


Figure 1 Test Circuit for Switching and Response Time

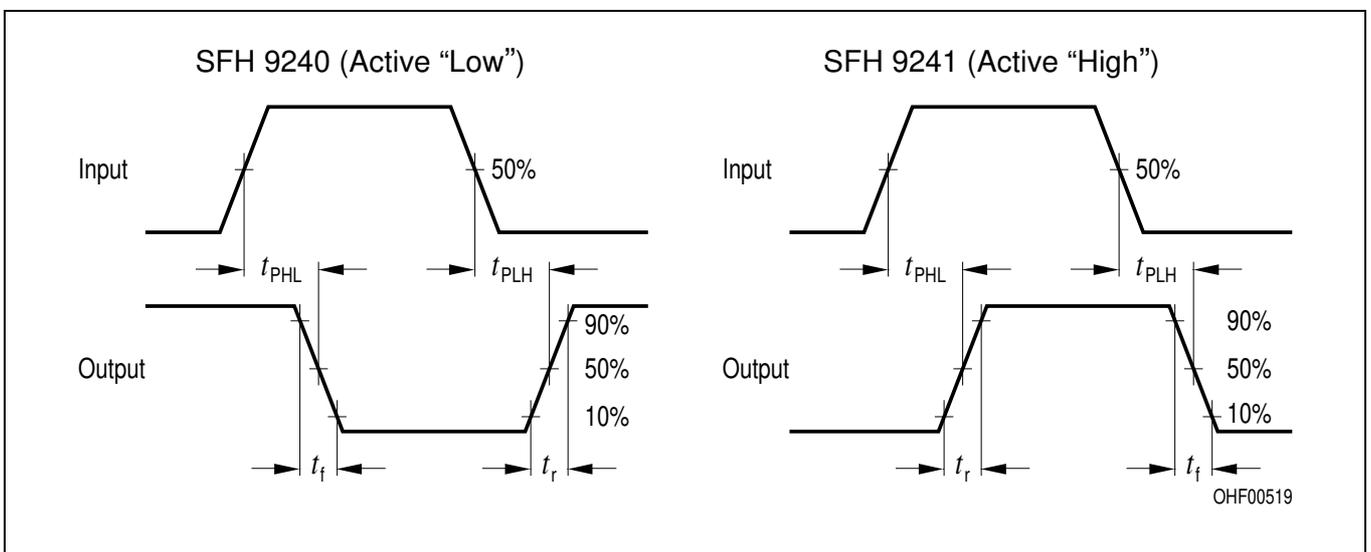
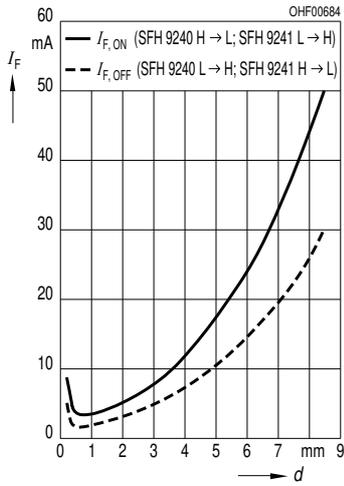
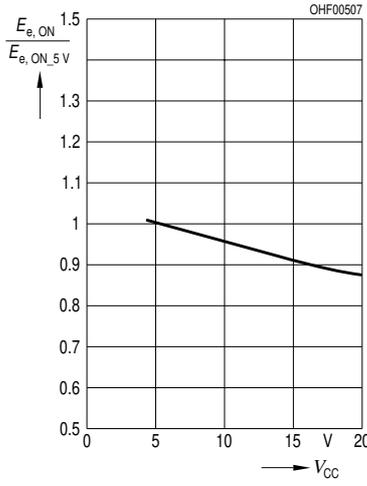


Figure 2 Switching Time Definitions

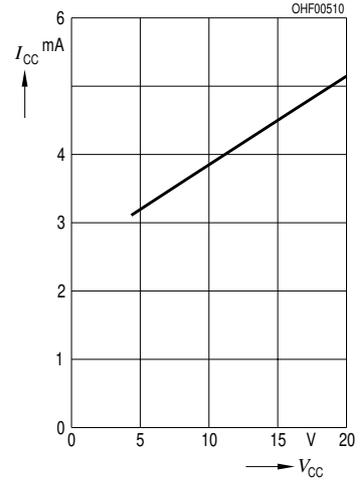
**Threshold Current vs. Distance**  
 $I_F = f(d)$



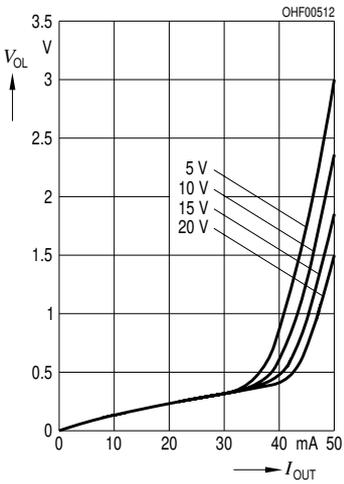
**Relative Threshold**  
 $E_{e,ON}/E_{e,ON VCC=5V} = f(V_{CC})$



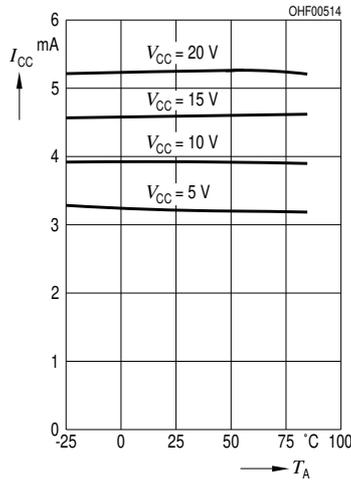
**Supply Current**  
 $I_{CC} = f(V_{CC})$



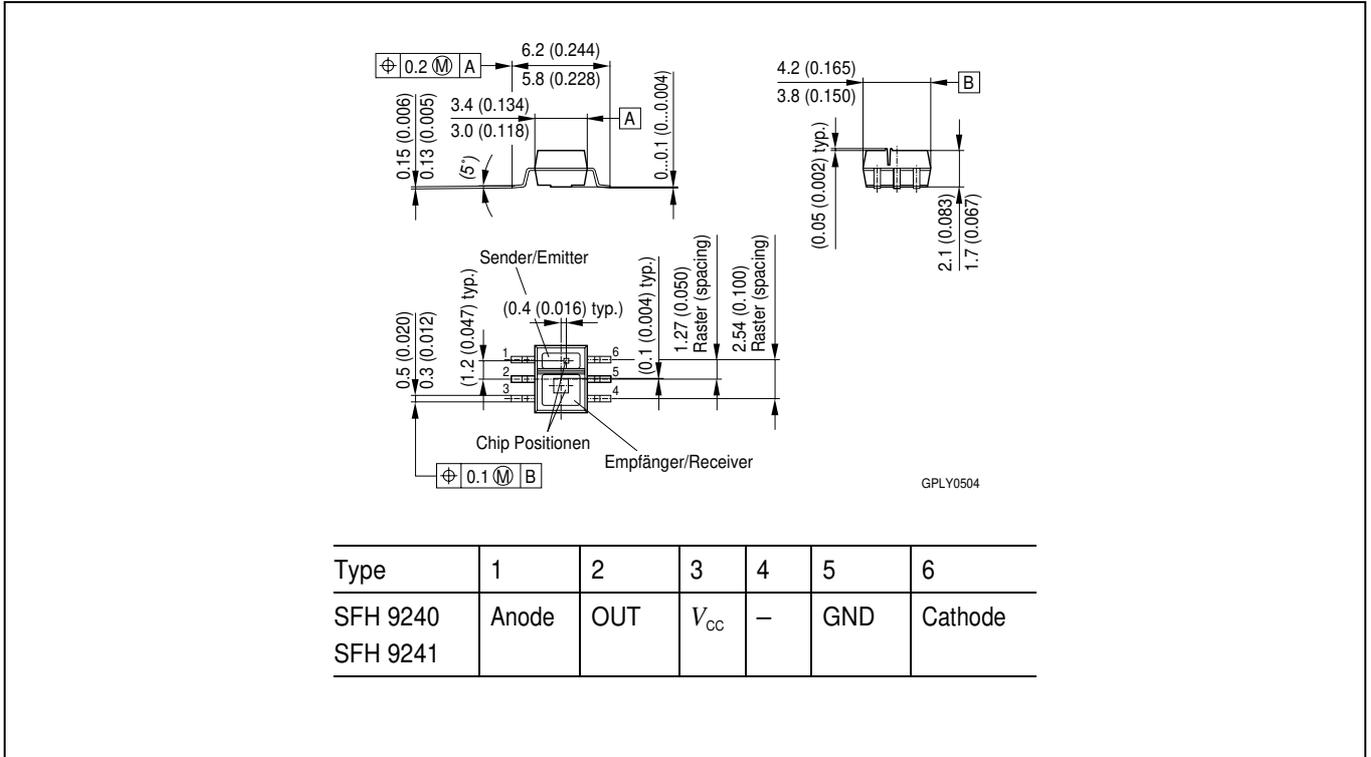
**Output Voltage**  
 $V_{OL} = f(I_{OUT}, V_{CC})$



**Supply Current vs. Ambient Temperature**  
 $I_{CC} = f(T_A, V_{CC})$



Maßzeichnung  
Package Outlines



Maße werden wie folgt angegeben: mm (inch) / Dimensions are specified as follows: mm (inch).

**Löthinweise**  
**Soldering Conditions**

Bauform Type	Drypack Level acc. to JEDEC A112-A	Tauch-, Schwalllötung Dip, Wave Soldering		Reflowlötung Reflow Soldering		Kolbenlötung Iron Soldering (Iron temp.)
		Peak Temp. (solderbath)	Max. Time in Peak Zone	Peak Temp. (package temp.)	Max. Time in Peak Zone	
SFH 9240 SFH 9241	4	n. a.	–	245 °C	10 sec.	n.a.

Bitte Verarbeitungshinweise für SMT-Bauelemente beachten!

Please observe the handling guidelines for SMT devices!

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